



MORE[®] | 茂昌电子
CHANCE

CUSTOMER : STD
PRODUCTS : SHIELDED SMD POWER INDUCTOR
PART NO : MCSHC Series
CUST P/ NO : _____
DATE : 2021.08.30
SALES DEP : _____
E-MAIL : _____

VERSION : REV.A
CHANGE PROJECT : -
BEFORE : -
AFTER : -
CHANGE DATE : -
CUSTOMER SIGNATURE : -

APPROVAL BY :	CHECK BY :	DRAWN BY :
<i>Honey Wei</i>	<i>Leo Wang</i>	<i>May Gao</i>



MCSHC Series



- SHIELDED SMD POWER INDUCTOR
- Operating Temperature up to $-40\text{ }^{\circ}\text{C} \sim 125\text{ }^{\circ}\text{C}$
- High Current up to 95.0A
- Low DCR down to 0.18mOhms
- Environmental Lead free
- Environmental RoHS2.0 compliant
- Environmental halogen free
- Storage Temperature : $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$.
- Packaging 13"Reel, Plastic tape: 12~24 mm wide

FEATURES

- Ferrite based with lower core loss
- Ferrite High Bs material.
- Accurate&low DCR design
- Ultra high current capacity.

Applications

- Multi-phase and Vcore regulators.
- Server and desktop VRMs and EVRDs.
- Data networking and storage systems.
- Graphics cards and battery power systems.
- Buck Converter,VRMs.

PRODUCT IDENTIFICATION

MC SHC 444 Z R10 M R32
 ① ② ③ ④ ⑤ ⑥ ⑦

- ① Brand & Product classification
- ② Product Series NO.(SHC : SMD Power Inductors.)
- ③ External Dimensions.(444 : L:4.0 × W:4.0 × H:4.0) [mm]
- ④ Separator code.
- ⑤ Nominal Inductance

Example	Nominal Value
R22	0.22uH
1R0	1.0uH
100	10uH
101	100uH
70NH	70nH

- ⑥ Inductance Tolerance.(L: $\pm 15\%$; M: $\pm 20\%$; N: $\pm 30\%$)
- ⑦ Nominal DC Resistance.(R32 : 0.32m Ω)

Mechanical & Dimensions

(Unit: mm)

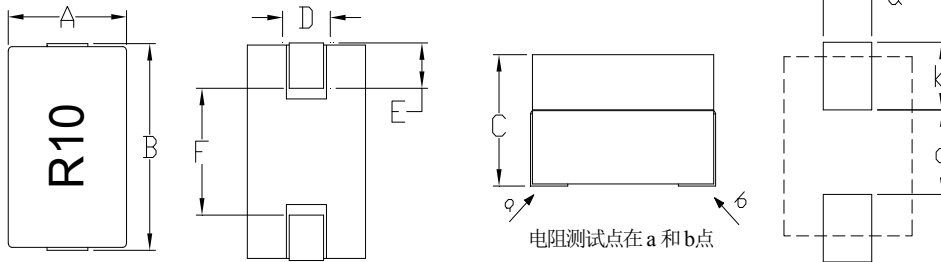
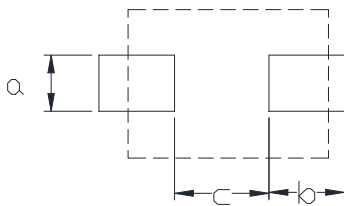


Fig. 26

Code	Dimensions
A	6.4 Max
B	9.6 Max
C	8.0 Max
D	2.14±0.2
E	2.3±0.3
F	4.6±0.3

Recommend Land Pattern Dimensions

(Unit: mm)



Code	Dimensions
a	2.54 Ref
b	3.2 Ref
c	4.0 Ref

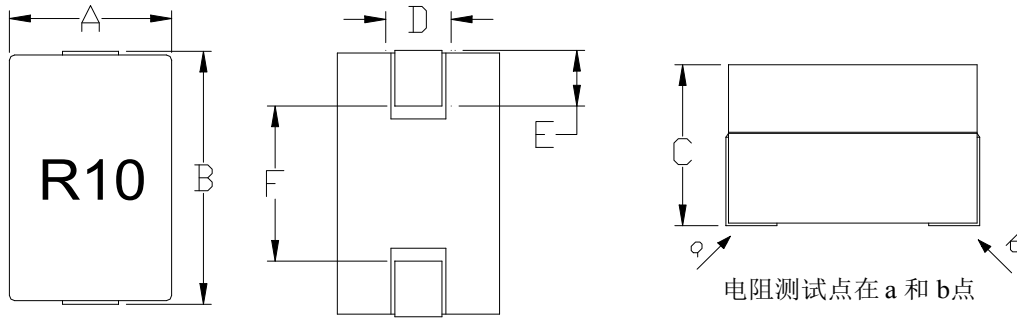
Electrical Characteristics

Part Number	Inductance ¹ (nH)	DCR ² (mΩ)	I-sat ^{3.1} (Amps)Max	I-sat ^{3.2} (Amps)Max	I-rms ⁴ (Amps)Typs
MCSHC09608ZR10LR29	100±15%	0.29±10%	94.0	81.0	51
MCSHC09608ZR12LR29	120±15%	0.29±10%	79.0	68.0	51
MCSHC09608ZR15LR29	150±15%	0.29±10%	65.0	54.0	51
MCSHC09608ZR22LR29	220±15%	0.29±10%	44.0	37.0	51
MCSHC09608ZR28LR29	280±15%	0.29±10%	34.0	29.0	51
MCSHC09608ZR30LR29	300±15%	0.29±10%	32.0	27.0	51

- Note:
1. Inductance is measured at 100 KHz and 1.0 Vrms at 25°C
 2. The nominal DCR is measured at 20°C ambient temperature.
 - 3.1 The I-sat that will cause initial inductance value approximately 20% rolloff at 25°C
 - 3.2 The I-sat that will cause initial inductance value approximately 20% rolloff at 125°C
 4. The I-rms that will cause temperature rise approximate 40°C without core loss.

Mechanical & Dimensions

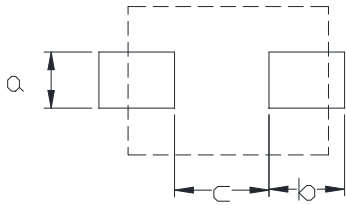
(Unit: mm)



Code	Dimensions
A	8.0 Max
B	10.6 Max
C	7.0 Max
D	2.1±0.2
E	2.2±0.3
F	5.7±0.5

Recommend Land Pattern Dimensions

(Unit: mm)



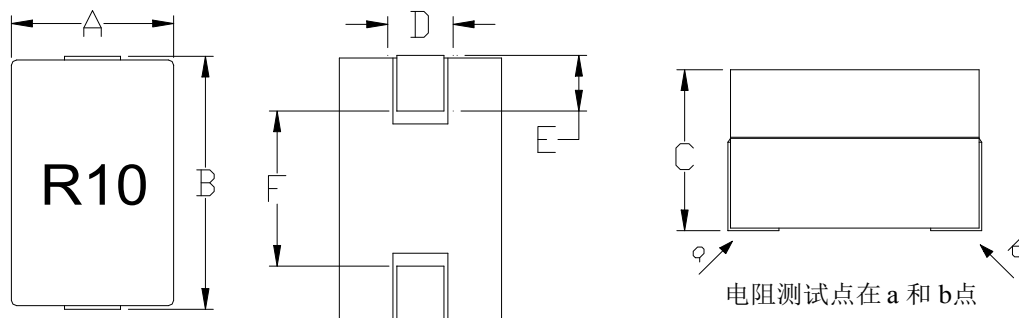
Code	Dimensions
a	2.6 Ref
b	3.0 Ref
c	5.0 Ref

Electrical Characteristics

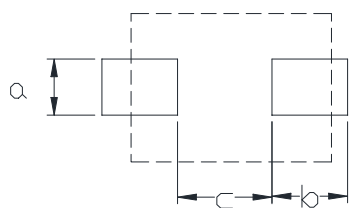
Part Number	Inductance ¹ (nH)	DCR ² (mΩ)	I-sat ^{3.1} (Amps)Max	I-sat ^{3.2} (Amps)Max	I-rms ⁴ (Amps)Typs
MCSHC10807ZR12LR29	120±15%	0.29±10%	94.0	86.0	61.0
MCSHC10807ZR15LR29	150±15%	0.29±10%	75.0	60.0	61.0
MCSHC10807ZR18LR29	180±15%	0.29±10%	60.0	50.0	61.0
MCSHC10807ZR22LR29	220±15%	0.29±10%	50.00	40.0	61.0
MCSHC10807ZR27LR29	270±15%	0.29±10%	41.00	33.0	61.0
MCSHC10807ZR30LR29	300±15%	0.29±10%	35.00	30.0	61.0
MCSHC10807ZR33LR29	330±15%	0.29±10%	33.00	26.0	61.0
MCSHC10807ZR39LR29	390±15%	0.29±10%	28.00	22.0	61.0
MCSHC10807ZR47LR29	470±15%	0.29±10%	23.00	19.0	61.0

Note:

1. Inductance is measured at 100 KHz and 1.0 Vrms at 25°C
2. The nominal DCR is measured at 20°C ambient temperature.
- 3.1 The I-sat that will cause initial inductance value approximately 20% rolloff at 25°C
- 3.2 The I-sat that will cause initial inductance value approximately 20% rolloff at 125°C
4. The I-rms that will cause temperature rise approximate 40°C without core loss.

Mechanical & Dimensions (Unit: mm)


Code	Dimensions
A	8.0 Max
B	10.4 Max
C	7.5 Max
D	2.25±0.2
E	2.54±0.3
F	5.1±0.5

Recommend Land Pattern Dimensions (Unit: mm)


Code	Dimensions
a	2.6 Ref
b	2.8 Ref
c	4.70 Ref

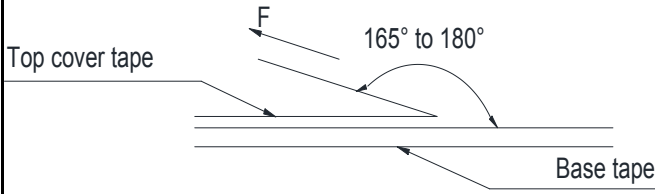
Electrical Characteristics

Part Number	Inductance ¹ (nH)	DCR ² (mΩ)	I-sat ^{3.1} (Amps)Max	I-sat ^{3.2} (Amps)Max	I-rms ⁴ (Amps)Typs
MCSHC10875ZR12LR29	120±15%	0.29±10%	94.0	86.0	61.0
MCSHC10875ZR15LR29	150±15%	0.29±10%	76.0	70.0	61.0
MCSHC10875ZR17LR29	170±15%	0.29±10%	66.0	60.0	61.0
MCSHC10875ZR22LR29	220±15%	0.29±10%	50.0	43.0	61.0
MCSHC10875ZR23LR29	230±15%	0.29±10%	48.0	40.0	61.0
MCSHC10875ZR27LR29	270±15%	0.29±10%	40.0	34.0	61.0
MCSHC10875ZR30LR29	300±15%	0.29±10%	35.0	30.0	61.0

- Note:
1. Inductance is measured at 100 KHz and 1.0 Vrms at 25°C
 2. The nominal DCR is measured at 20°C ambient temperature.
 - 3.1 The I-sat that will cause initial inductance value approximately 20% rolloff at 25°C
 - 3.2 The I-sat that will cause initial inductance value approximately 20% rolloff at 100°C
 4. The I-rms that will cause temperature rise approximate 40°C without core loss.

Packaging

Tearing Off Force:



The force tearing off cobe tape is 10 to 130 g.f			
in the arrow direction under the following conditions			
Room Temp (°C)	Room Humidity (%)	Room atrn (hPa)	Teaming Speed (mm/min)
5~35	45~85	860~1060	300

※Storage Conditions

1. Recommended products should be used within 6 months form the time of delivery.
2. The packaging material should be kept where no chlorine or sulfur exists in the air.

※Transportation

1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

Recommended Soldering Conditions

Figure 1. Re-flow Soldering

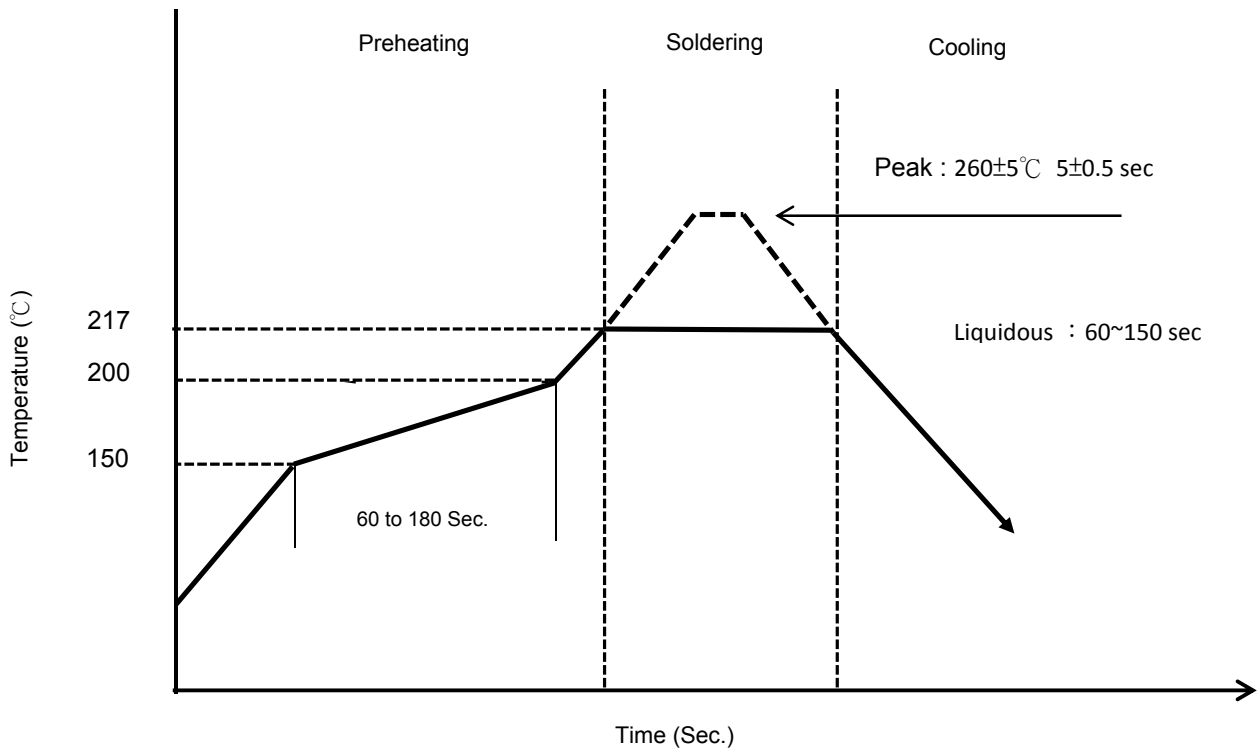
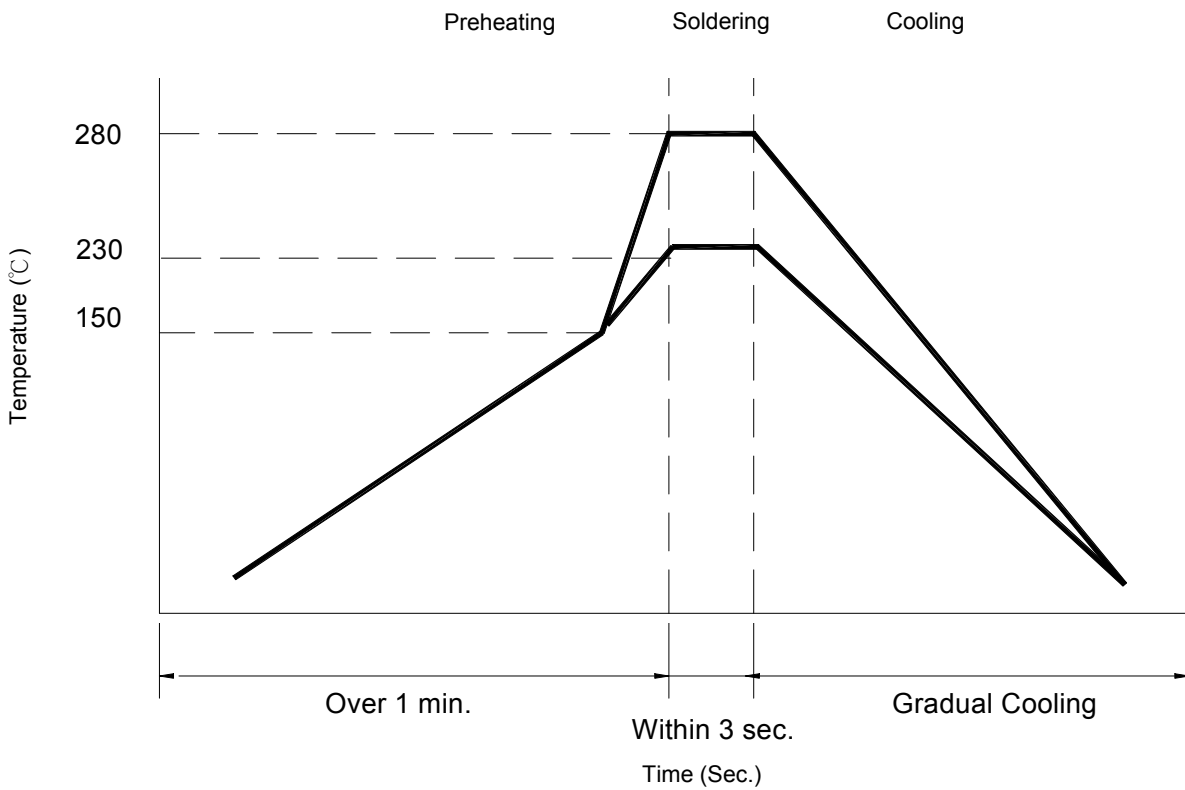
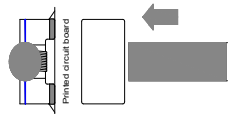


Figure 2. Hand Soldering



Reliability and Testing Conditions

Item	Specification	Conditions															
Operating temperature range	-40°C ~ +125°C (Including self-temperature rise)																
Storage temperature and humidity range	-40°C ~ +85°C , 70% RH Max																
Solderability	More than 90% of the terminal electrode should be covered with solder.	<ul style="list-style-type: none"> - Preheat: 150 °C , 60 sec - Solder: Sn96.5%-Ag3%-Cu0.5% - Temperature: 245±5°C - Flux for lead free: Rosin 9.5% - Dip time: 4±1 sec - Depth: completely cover the termination 															
Resistance to Soldering Heat	Inductance within ±20% of initial value. No disconnection or short circuit. The appearance shall not break.	<ul style="list-style-type: none"> - Solder technique simulation: SMD - Temperature (°C): 260 ± 5 (solder temp) - Time (s): 10 ± 1 - Temperature ramp / immersion and emersion rate: 25 mm/s ± 6 mm/s - Number of heat cycles: 1 															
Resistance to High Temperature	Inductance within ±20% of initial value. No disconnection or short circuit. The appearance shall not break.	500 hrs. at 125°C±5°C Unpowered. Measurement at 24±4 hours after test conclusion.															
Resistance to Low Temperature	Inductance within ±20% of initial value. No disconnection or short circuit. The appearance shall not break.	500 hrs. at -40°C±5°C. Unpowered. Measurement at 24±4 hours after test conclusion.															
Resistance to Humidity	Inductance within ±20% of initial value. No disconnection or short circuit. The appearance shall not break.	After 500 hours in 40±2°C and 90 to 95% humidity , and 2 hour drying under normal condition.															
Thermal shock	Inductance within ±20% of initial value. No disconnection or short circuit. The appearance shall not break.	<p>After 100 cycles of following condition.</p> <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>Step</th> <th>Temperature (°C)</th> <th>Times (min.)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-40±5°C</td> <td>30</td> </tr> <tr> <td>2</td> <td>Room Temperature</td> <td>Within 3</td> </tr> <tr> <td>3</td> <td>125±5°C</td> <td>30</td> </tr> <tr> <td>4</td> <td>Room Temperature</td> <td>Within 3</td> </tr> </tbody> </table>	Step	Temperature (°C)	Times (min.)	1	-40±5°C	30	2	Room Temperature	Within 3	3	125±5°C	30	4	Room Temperature	Within 3
Step	Temperature (°C)	Times (min.)															
1	-40±5°C	30															
2	Room Temperature	Within 3															
3	125±5°C	30															
4	Room Temperature	Within 3															
Vibration Test	Inductance within ±10% of initial value and appearance shall not break.	After vibration for 1hour, In each of three orientations at sweep vibration (10~55~10Hz) with 1.52mm P-P Amplitudes.															
Terminal strength	The terminal electrode and the ferrite must not be damaged	<p>Solder a chip to test substrate, and then laterally apply a load 10N in the arrow direction, Duration :5s</p> 															
Drop Test	Inductance within ±20% of initial value. The appearance shall not break.	Drop 3 times on a concrete floor from a height of 75cm by inimum packing															